

RoHS COMPLIANT

N-Channel 45 V (D-S) MOSFET

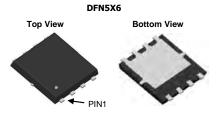
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Typ.)		
45	0.0008 at V _{GS} = 10 V	230	110 nC		
45	0.0012 at V _{GS} = 4.5 V	170	TIUTIC		

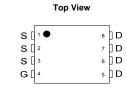
FEATURES

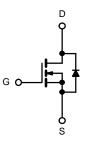
- DT-Trench Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

- Notebook PC Core
- VRM/POL •







N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	45	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		230 ^{a, e}		
Continuous Drain Current (T _J = 175 °C)	T _C = 70 °C	I _D	190 ^e		
Continuous Drain Current $(1_j = 175 C)$	T _A = 25 °C	D	52 ^{b, c}	A	
	T _A = 70 °C		38.2 ^{b, c}		
Pulsed Drain Current	I _{DM}	820			
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	79		
Single Pulse Avalanche Energy			750	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	230 ^{a, e}	A	
Continuous Source-Drain Diode Current	T _A = 25 °C	'5	13.6 ^{b, c}		
	T _C = 25 °C		320 ^a		
Maximum Power Dissipation	T _C = 70 °C	PD	224	W	
	T _A = 25 °C	U U	8.15 ^{b, c}		
	T _A = 70 °5		5.71 ^{b, c}		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	$t \le 10 \text{ s}$	R _{thJA}	10	13	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.35	0.5	C/W	

Notes:

a. Based on $T_C = 25$ °C. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Calculated based on maximum junction temperature. Package limitation current is 180 A.

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Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	45			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		35		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η = 200 μΛ		- 5.5		mv/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	1	$V_{DS} = 32 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	V _{DS} = 32 V, V _{GS} = 0 V		1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 32 V, V_{GS} = 0 V, T_{J} = 55 °C$			10	- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	200			А	
	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.0008	0.0012		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0012	0.0016	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		80		S	
Dynamic ^b			•				
Input Capacitance	C _{iss}			4600			
Output Capacitance	C _{oss}	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz		3100		pF	
Reverse Transfer Capacitance	C _{rss}			105			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		110			
				59.3		nC	
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 20 A		18			
Gate-Drain Charge	Q _{gd}			13			
Gate Resistance	Rg	f = 1 MHz		1.4	2.1	Ω	
Turn-On Delay Time	t _{d(on)}			14	22	-	
Rise Time	t _r	V_{DD} = 15 V, R_L = 0.555 Ω		10	16		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 30A, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		56	85		
Fall Time	t _f			10	15	20	
Turn-On Delay Time	t _{d(on)}			12	20	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 0.625 Ω		150	220		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 20 A, V_{GEN} = 4.5 V, R_g = 1 Ω		55	83		
Fall Time	t _f			12	18		
Drain-Source Body Diode Characteristic	s		•				
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			230	^	
Pulse Diode Forward Current ^a	I _{SM}				820	A	
Body Diode Voltage	V _{SD}	I _S = 22 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			35	58	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 20 A, di/dt = 100 A/μs, T _J = 25 °C		90.2	125	nC	
Reverse Recovery Fall Time	t _a	$F = 20 \text{ A}, \text{ al/al} = 100 \text{ A/}\text{µs}, T_J = 25 \text{ °C}$		27			
Reverse Recovery Rise Time t _b				25		ns	

Notes:

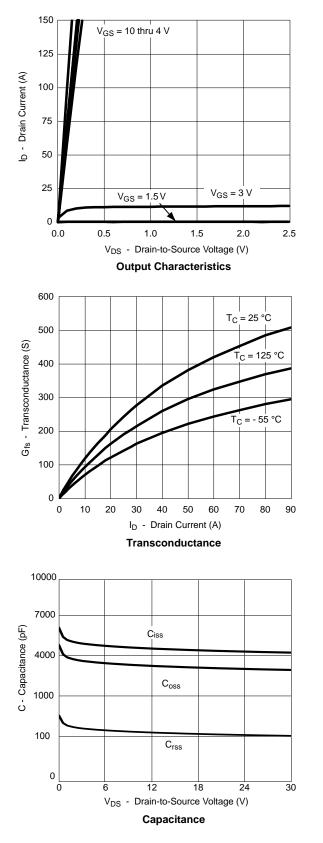
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

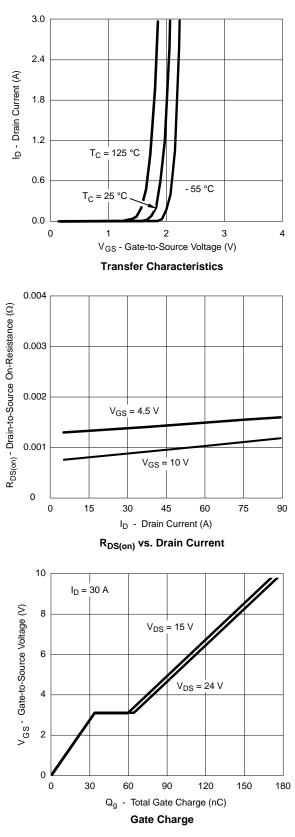
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

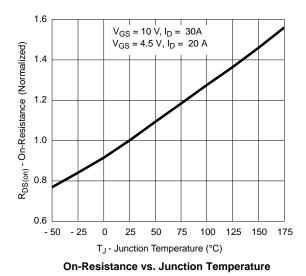


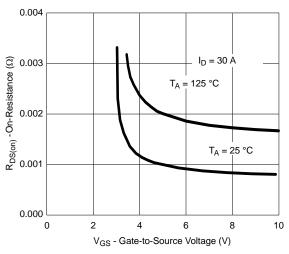


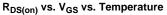


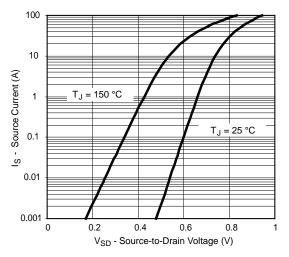
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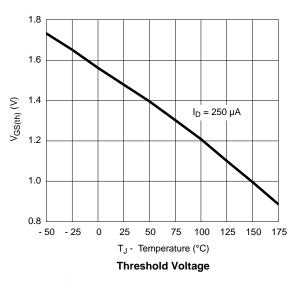


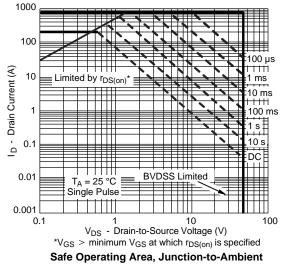




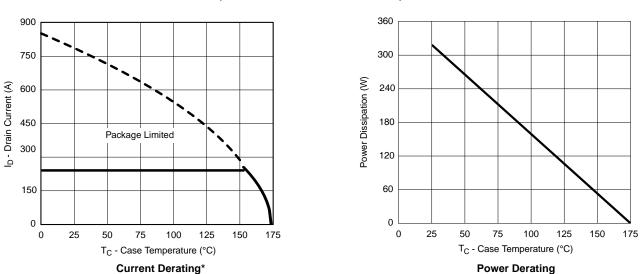


Forward Diode Voltage vs. Temperature



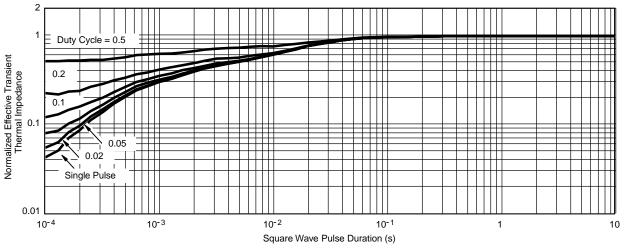






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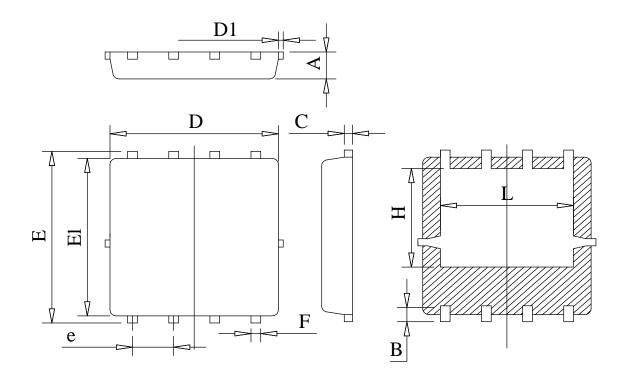
* The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case



DFN5X6-8L PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Unit : mm			
Symbol	Min	Тур	Max
А	0.78	0.95	1.12
В	0.45	0.58	0.78
С	0.18	0.254	0.36
D	4.70	5.20	5.45
D1			0.18
E	5.85	6.05	6.25
E1	5.38	5.55	5.98
e	1.15	1.27	1.40
F	0.18	0.30	0.52
Н	3.25	3.47	3.70
L	3.75	4.00	4.25



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